



# Power MOSFETS

---

## DATASHEET

**LM45010NAM8A**

N-Channel  
Enhancement Mode MOSFET

- Leadpower-semi CO., LTD.
- sales@leadpower-semi.com
- (03) 6577339 FAX : (03) 6577229
- [www.leadpower-semi.com](http://www.leadpower-semi.com)



Quality Management Systems  
ISO 9001:2015 Certificate

## N-Channel Enhancement Mode MOSFET

### Pin Description

LFPACK56		Symbol	Product Summary	Symbol	N-Channel	Unit
Top view	Bottom view			D	G	S
				V <sub>DSS</sub>	45	V
				R <sub>DSON-Max</sub>	0.7	mΩ
				I <sub>D</sub>	358	A

### Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested
- Moisture Sensitivity Level MSL1

### Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM45010NAM8A	LFPACK56	Tape & Reel	4000 / Tape & Reel	45010 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note :     = Lot Code

### Absolute Maximum Ratings (T<sub>J</sub>=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V <sub>DSS</sub>	Drain-Source Voltage	45	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	
T <sub>J</sub>	Maximum Junction Temperature	175	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 175	°C
I <sub>S</sub>	Diode Continuous Forward Current	T <sub>c</sub> =25°C 108	A
I <sub>SP</sub> <sup>①</sup>	Diode Pulse Current	T <sub>c</sub> =25°C 400	A
I <sub>DM</sub> <sup>①</sup>	Pulse Drain Current Tested	T <sub>c</sub> =25°C 895	A
I <sub>D</sub>	Continuous Drain Current	T <sub>c</sub> =25°C 358 T <sub>c</sub> =100°C 253	A
P <sub>D</sub>	Maximum Power Dissipation	T <sub>c</sub> =25°C 167 T <sub>c</sub> =100°C 83	W
I <sub>D</sub>	Continuous Drain Current	T <sub>A</sub> =25°C 51 T <sub>A</sub> =70°C 42	A
P <sub>D</sub>	Maximum Power Dissipation	T <sub>A</sub> =25°C 3.3 T <sub>A</sub> =70°C 2.3	W
I <sub>AS</sub> <sup>②</sup>	Avalanche Current, Single pulse	L=0.1mH 66 L=0.5mH 36	A
E <sub>AS</sub> <sup>②</sup>	Avalanche Energy, Single pulse	L=0.1mH 218 L=0.5mH 324	mJ

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
R <sub>θJC</sub>	Thermal Resistance-Junction to Case	Steady State 0.9	°C/W
R <sub>θJA</sub> <sup>③</sup>	Thermal Resistance-Junction to Ambient	Steady State 45	°C/W

Note ① : Max. current is limited by maximum junction temperature.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 175°C

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz

**N-Channel Electrical Characteristics (T<sub>J</sub>=25°C Unless Otherwise Noted)**

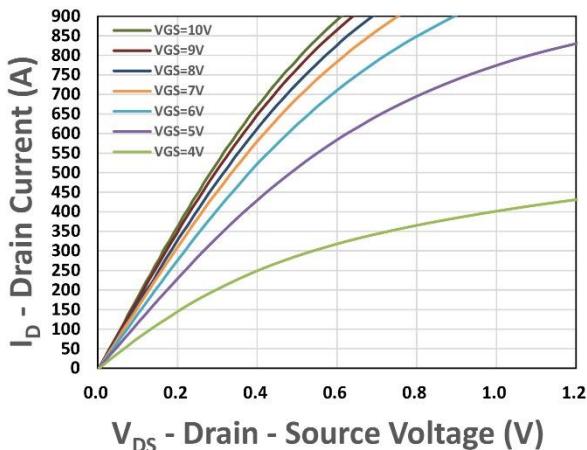
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
<b>BV<sub>DSS</sub></b>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250uA	45	-	-	V
<b>I<sub>DSS</sub></b>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =36V, V <sub>GS</sub> =0V	-	-	1	uA
<b>V<sub>GS(th)</sub></b>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250uA	1	1.7	2.3	V
<b>I<sub>GSS</sub></b>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
<b>R<sub>DS(on)</sub><sup>④</sup></b>	Drain-Source On-state Resistance	V <sub>GS</sub> =10V, I <sub>DS</sub> =20A	-	0.55	0.7	mΩ
		V <sub>GS</sub> =4.5V, I <sub>DS</sub> =10A	-	1.0	1.35	
<b>g<sub>f</sub>s</b>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>DS</sub> =10A	-	52	-	S
<b>Dynamic Characteristics <sup>⑤</sup></b>						
<b>R<sub>G</sub></b>	Gate Resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, Freq.=1MHz	-	0.5	-	Ω
<b>C<sub>iss</sub></b>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =20V, Freq.=1MHz	-	6210	-	pF
<b>C<sub>oss</sub></b>	Output Capacitance		-	2064	-	
<b>C<sub>rss</sub></b>	Reverse Transfer Capacitance		-	118	-	
<b>t<sub>d(on)</sub></b>	Turn-on Delay Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =1A, R <sub>GEN</sub> =1Ω	-	17	-	nS
<b>t<sub>r</sub></b>	Turn-on Rise Time		-	11	-	
<b>t<sub>d(off)</sub></b>	Turn-off Delay Time		-	52	-	
<b>t<sub>f</sub></b>	Turn-off Fall Time		-	92	-	
<b>Q<sub>g</sub></b>	Total Gate Charge	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =20V, I <sub>D</sub> =20A	-	44	-	nC
<b>Q<sub>g</sub></b>	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =20A	-	87	-	nC
<b>Q<sub>gs</sub></b>	Gate-Source Charge		-	17	-	
<b>Q<sub>gd</sub></b>	Gate-Drain Charge		-	15	-	
<b>Source-Drain Characteristics</b>						
<b>V<sub>SD</sub><sup>④</sup></b>	Diode Forward Voltage	I <sub>SD</sub> =10A, V <sub>GS</sub> =0V	-	0.75	1.1	V
<b>t<sub>rr</sub></b>	Reverse Recovery Time	I <sub>F</sub> =10A, V <sub>R</sub> =20V	-	62	-	nS
<b>Q<sub>rr</sub></b>	Reverse Recovery Charge	dl <sub>F</sub> /dt=100A/μs	-	92	-	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

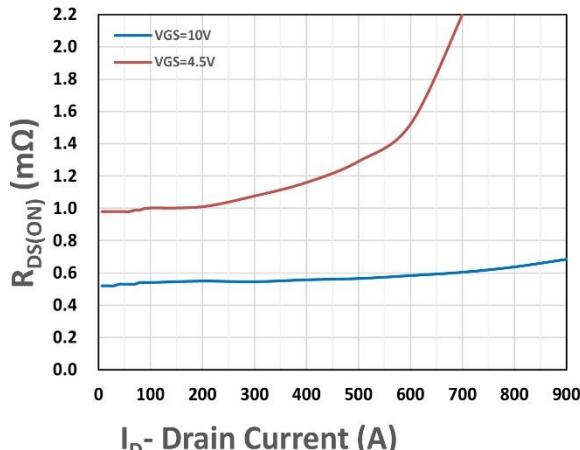
# LM45010NAM8A

## N-Channel Typical Characteristics



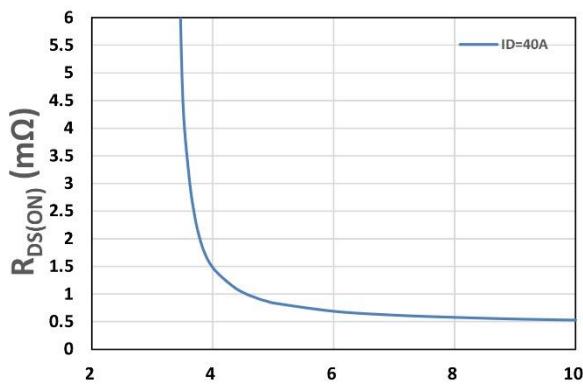
$V_{DS}$  - Drain - Source Voltage (V)

Figure 1. Output Characteristics



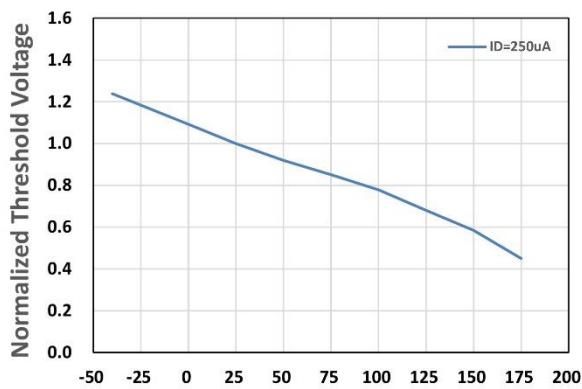
$I_D$  - Drain Current (A)

Figure 2. On-Resistance vs. ID



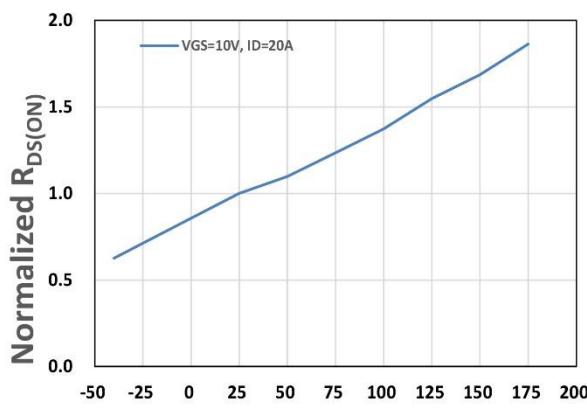
$V_{GS}$  - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



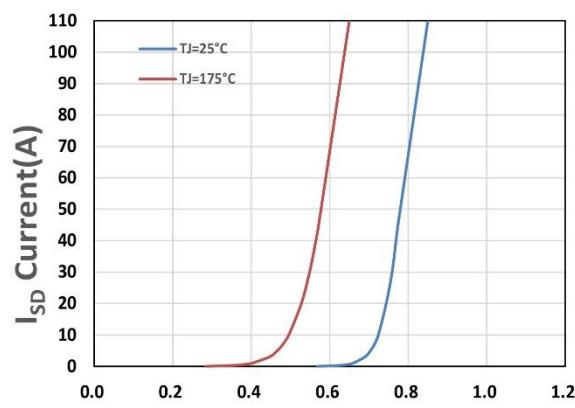
$T_j$ , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



$T_j$  , Junction Temperature(°C)

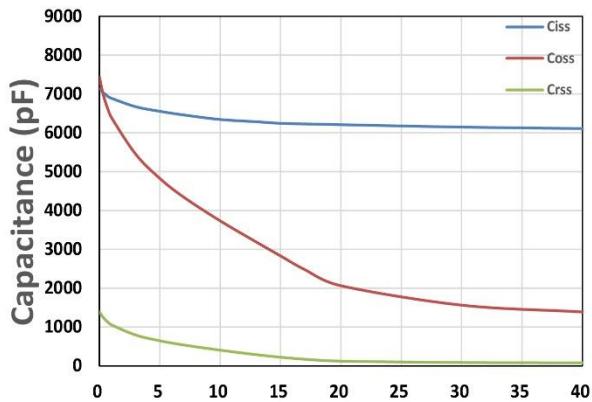
Figure 5. Drain-Source On Resistance



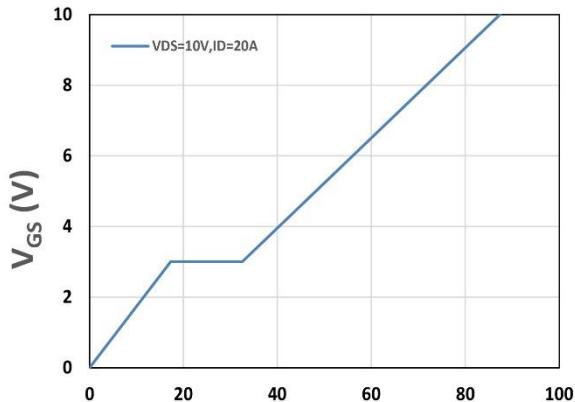
$V_{SD}$ , Source-Drain Voltage(V)

Figure 6. Source-Drain Diode Forward

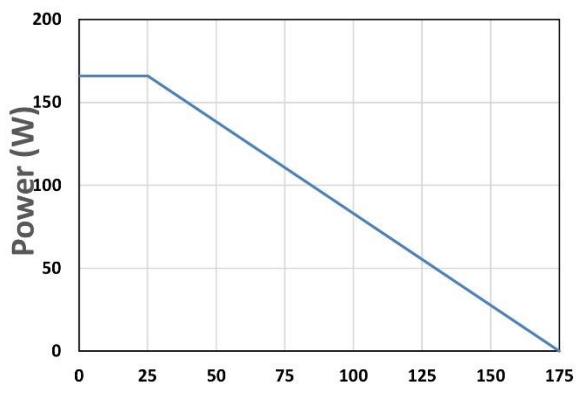
# LM45010NAM8A



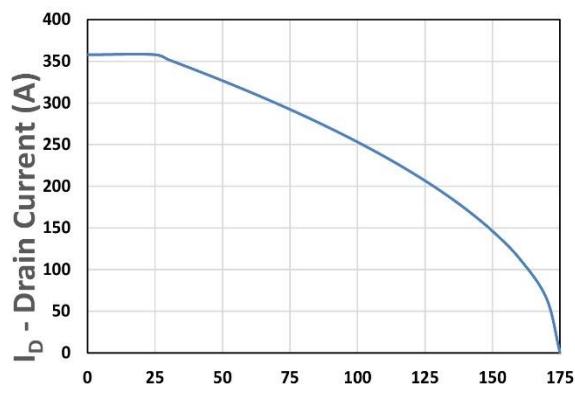
$V_{DS}$  - Drain - Source Voltage (V)  
Figure 7. Capacitance



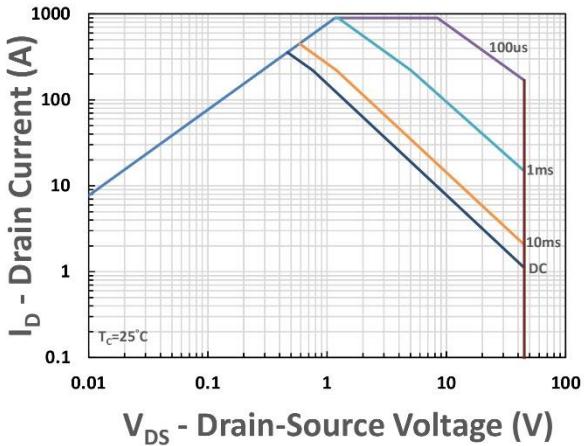
$Q_g$ , Total Gate Charge (nC)  
Figure 8. Gate Charge Characteristics



$T_c$ -Case Temperature (°C)  
Figure 9. Power Dissipation

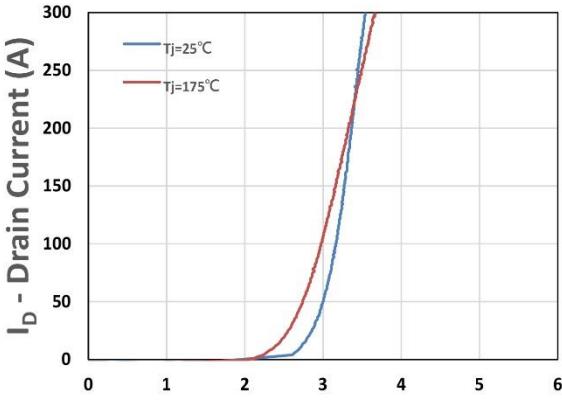


$T_c$ -Case Temperature (°C)  
Figure 10. Drain Current



$I_D$  - Drain Current (A)  
 $V_{DS}$  - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



$I_D$  - Drain Current (A)  
 $V_{GS}$  - Gate - Source Voltage (V)

Figure 12. Transfer Characteristics

# LM45010NAM8A

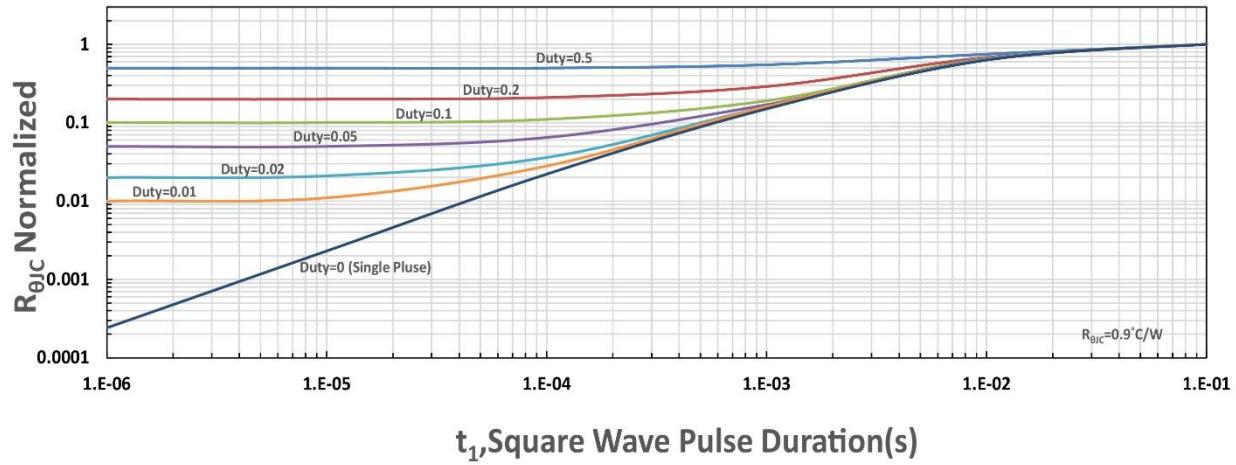


Figure 13.  $R_{\theta JC}$  Transient Thermal Impedance